

1.5A, 400V - 1000V Glass Passivated Bridge Rectifiers

FEATURES

- Ideal for automated placement
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

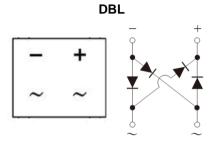
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MECHANICAL DATA

Case: Molded plastic body Molding compound: UL flammability classification rating 94V-0 Packing code with suffix "G" means green compound (halogen-free) Terminal: Matte tin plated leads, solderable per J-STD-002 Meet JESD 201 class 1A whisker test Polarity: Polarity as marked on the body Weight: 0.36 g (approximately)



DADAMETED	exhibol	DBL	DBL	DBL	DBL	UNIT
PARAMETER	SYMBOL	154G-T	155G-T	156G-T	157G-T	
Marking code		DBL154G	DBL155G	DBL156G	DBL157G	
Maximum repetitive peak reverse voltage	V _{RRM}	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	400	600	800	1000	V
Maximum average forward rectified current	I _{F(AV)}	1.5				Α
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	50			А	
Rating for fusing (t<8.3ms)	l ² t	10.3			A ² s	
Maximum instantaneous forward voltage (Note 1) I_F = 1.5 A	V _F	1.1		V		
Maximum reverse current @ rated V_R T _J =25°C T _J =125°C	I _R	2 500		μA		
Typical junction capacitance per leg (Note 2)	CJ	25			pF	
Typical thermal resistance	R _{θJL} R _{θJA}	15 40			°C/W	
Operating junction temperature range	TJ	- 55 to +150			°C	
Storage temperature range	T _{STG}	- 55 to +150			°C	

Note 1: Pulse test with PW=300µs,1% duty cycle

Note 2: Measure at 1.0MHz and applied reverse voltage of 4.0 V $\,$



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ORDERING INFORMATION

PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
DBL15xG-T (Note 1, 2)	СВ	G	DBL	50 / TUBE

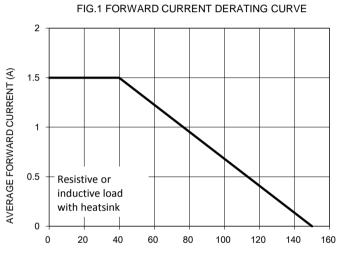
Note 1: "x" defines voltage from 400V (DBL154G-T) to 1000V (DBL157G-T)

Note 2: Whole series with green compound

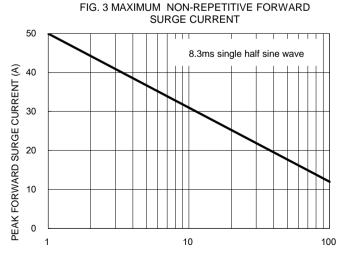
EXAMPLE					
EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION	
DBL157G-T CBG	DBL157G-T	СВ	G	Green compound	

RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)



AMBIENT TEMPERATURE (C)



NUMBER OF CYCLES AT 60 Hz

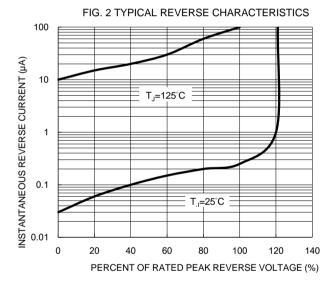


FIG. 4 TYPICAL FORWARD CHARACTERISTICS

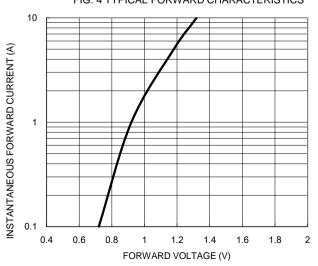
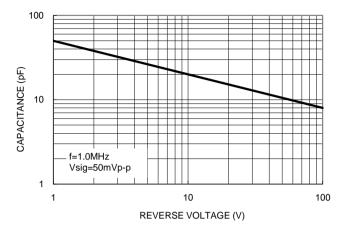
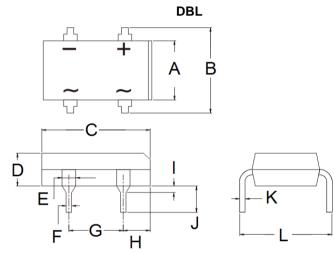




FIG. 5 TYPICAL JUNCTION CAPACITANCE



PACKAGE OUTLINE DIMENSIONS



DIM.	Unit (mm)		Unit (inch)		
DIN.	Min	Max	Min	Max	
А	6.20	6.50	0.244	0.256	
В	7.24	8.00	0.285	0.315	
С	8.12	8.51	0.320	0.335	
D	2.35	2.60	0.093	0.102	
E	0.89	1.14	0.035	0.045	
F	0.46	0.58	0.018	0.023	
G	5.00	5.20	0.197	0.205	
Н	1.39	1.90	0.055	0.075	
-	1.27	2.03	0.050	0.080	
J	3.81	4.69	0.150	0.185	
К	0.22	0.33	0.009	0.013	
L	7.60	8.90	0.299	0.350	

MARKING DIAGRAM



P/N	= Specific Device Code
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G = Green Compound

- YW = Date Code
- F = Factory Code



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